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November 2013



FGH40N60SMDF 600 V, 40 A Field Stop IGBT

Features

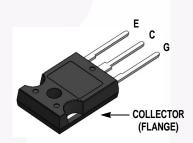
- Maximum Junction Temperature : $T_J = 175^{\circ}C$
- Positive Temperaure Co-efficient for Easy Parallel Operating
- High Current Capability
- Low Saturation Voltage: $V_{CE(sat)} = 1.9 V(Typ.) @ I_C = 40 A$
- High Input Impedance
- Fast Switching: E_{OFF} = 6.5 uJ/A
- Tightened Parameter Distribution
- RoHS Compliant

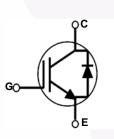
Applications

• Solar Inverter, UPS, Welder, PFC, Telecom, ESS

General Description

Using Novel Field Stop IGBT Technology, Fairchild's new series of field stop 2nd generation IGBTs offer the optimum performance for solar inverter, UPS, welder, telecom, ESS and PFC applications where low conduction and switching losses are essential.





Absolute Maximum Ratings

Symbol	Description		Ratings	Unit	
V _{CES}	Collector to Emitter Voltage		600	V	
V _{GES}	Gate to Emitter Voltage		± 20	V	
I _C	Collector Current	@ T _C = 25 ^o C	80	A	
	Collector Current	@ T _C = 100°C	40	A	
I _{CM (1)}	Pulsed Collector Current	@ T _C = 25 ^o C	120	A	
P _D	Maximum Power Dissipation	@ T _C = 25°C	349	W	
	Maximum Power Dissipation	@ T _C = 100 ^o C	174	W	
TJ	Operating Junction Temperature		-55 to +175	°C	
T _{stg}	Storage Temperature Range		-55 to +175	°C	
TL	Maximum Lead Temp. for soldering Purposes, 1/8" from case for 5 seconds		300	°C	

Notes:

1: Repetitive rating: Pulse width limited by max. junction temperature

Thermal Characteristics

Symbol	Parameter	Тур.	Max.	Unit
$R_{\theta JC}$ (IGBT)	$R_{\theta JC}$ (IGBT) Thermal Resistance, Junction to Case		0.43	°C/W
$R_{\theta JC}$ (Diode)	Thermal Resistance, Junction to Case	-	1.45	°C/W
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction to Ambient	-	40	°C/W

Part Nu	mber	Top Mark	Package	Packing Method	Reel Size	Tape W	idth	Quantity
FGH40N60SMDF FGH40N60SMDF TO-247		TO-247	Tube	N/A	N/A		30	
Electric	al Ch	aracteristics	of the IG	BT $T_{C} = 25^{\circ}C$ unless otherw	ise noted			
Symbol		Parameter		Test Condition	s Min.	Тур.	Max	. Unit
	4				l.		-	
Off Charac				V 0.V 1 250 ··· A	600			V
BV _{CES}		ctor to Emitter Breakdown Voltage erature Coefficient of Breakdown		$V_{GE} = 0 V, I_{C} = 250 \mu A$	600	-	-	V
ΔΒV _{CES} ΔΤ _J	Voltage		Breakdown	$V_{GE} = 0 \text{ V}, \text{ I}_{C} = 250 \mu\text{A}$	-	0.6	-	V/ºC
I _{CES}	Collect	ctor Cut-Off Current		$V_{CE} = V_{CES}, V_{GE} = 0 V$		-	250	μΑ
I _{GES}	G-E Le	eakage Current		$V_{GE} = V_{GES}, V_{CE} = 0 V$		-	±400) nA
On Charac	teristics							
V _{GE(th)}		reshold Voltage		I _C = 250 μA, V _{CE} = V _{GE}	3.5	4.6	6.0	V
				$I_{\rm C} = 40$ A, $V_{\rm GE} = 15$ V	-	1.9	2.5	V
V _{CE(sat)}	Collect	tor to Emitter Saturation Voltage		$I_{C} = 40 \text{ A}, V_{GE} = 15 \text{ V},$ $T_{C} = 150^{\circ}\text{C}$	-	2.1	-	V
Dynamic C	1						1	
C _{ies}	-	apacitance			-	1880	-	pF
C _{oes}		Capacitance		V _{CE} = 30 V _, V _{GE} = 0 V, f = 1 MHz	-	180	-	pF
C _{res}	Revers	se Transfer Capacitance			-	50	-	pF
Switching	Charact	eristics						
t _{d(on)}	Turn-O	rn-On Delay Time			-	12	-	ns
t _r	Rise Ti	me			-	20	-	ns
t _{d(off)}	Turn-O	ff Delay Time		V _{CC} = 400 V, I _C = 40 A,	-	92	-	ns
t _f	Fall Tin	ne		$R_{G} = 6 \Omega, V_{GE} = 15 V,$	-	13	20	ns
E _{on}	Turn-O	n Switching Loss		Inductive Load, T _C = 25°C	; -	1.3	-	mJ
E _{off}	Turn-O	ff Switching Loss			-	0.26	-	mJ
E _{ts}	Total S	witching Loss			-	1.56	-	mJ
t _{d(on)}	Turn-O	n Delay Time			-	12	-	ns
t _r	Rise Ti	me			-	19	- 1	ns
t _{d(off)}	Turn-O	ff Delay Time		V _{CC} = 400 V, I _C = 40 A,	-	97	-	ns
t _f	Fall Tin	ne		$R_G = 6 \Omega$, $V_{GE} = 15 V$, Inductive Load, $T_C = 150^{\circ}C$	-	14	21	ns
E _{on}	Turn-O	n Switching Loss			- C	2.09	-	mJ
E _{off}	Turn-O	ff Switching Loss			-	0.44	-	mJ
E _{ts}	Total S	witching Loss			-	2.53	-	mJ
Qg	Total G	ate Charge			-	119	-	nC
Q _{ge}	Gate to	Emitter Charge		$V_{CE} = 400 \text{ V}, I_C = 40 \text{ A},$	-	13	-	nC
Q _{gc}	Gate to	Collector Charge		V _{GE} = 15 V	-	58	-	nC

FGH40N60SME
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600 V,
V, 40 A F
ield (
Stop IG
IGBT

Symbol	Parameter	Test Condition	าร	Min.	Тур.	Max	Unit
V _{FM}	Diode Forward Voltage	I _F = 20 A	$T_C = 25^{\circ}C$	-	1.3	1.7	V
			$T_{\rm C} = 150^{\rm o}{\rm C}$	-	1.2		
t _{rr}	Diode Reverse Recovery Time	I _F =20 A, di _F /dt = 200 A/μs	$T_{\rm C} = 25^{\rm o}{\rm C}$	-	70	90	ns
			$T_{\rm C} = 150^{\rm o}{\rm C}$	-	126		
Q _{rr}	Diode Reverse Recovery Charge		$T_{\rm C} = 25^{\rm o}{\rm C}$	-	207	290	nC
			$T_{\rm C} = 150^{\rm o}{\rm C}$	-	638		

Typical Performance Characteristics



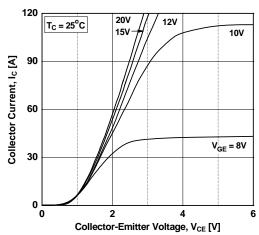


Figure 3. Typical Saturation Voltage Characteristics

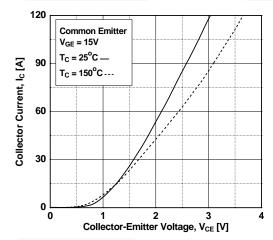
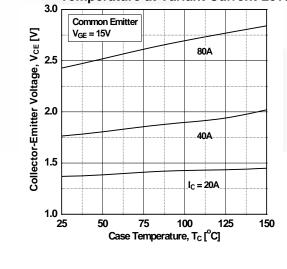


Figure 5. Saturation Voltage vs. Case Temperature at Variant Current Level





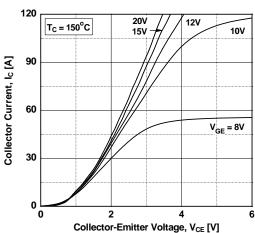


Figure 4. Transfer Characteristics

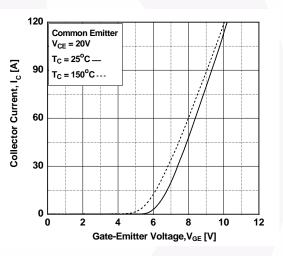
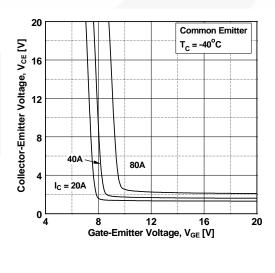
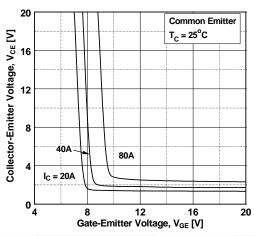


Figure 6. Saturation Voltage vs. V_{GE}

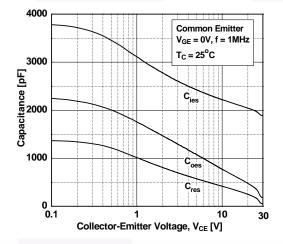


Typical Performance Characteristics











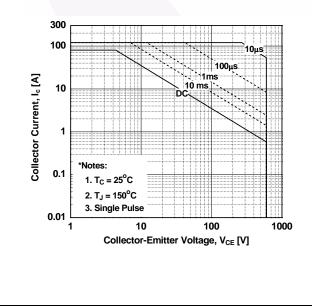


Figure 8. Saturation Voltage vs. V_{GE}

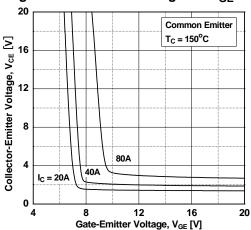


Figure 10. Gate charge Characteristics

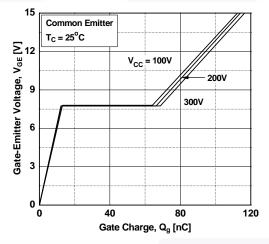
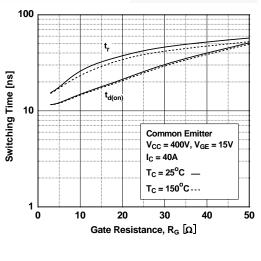
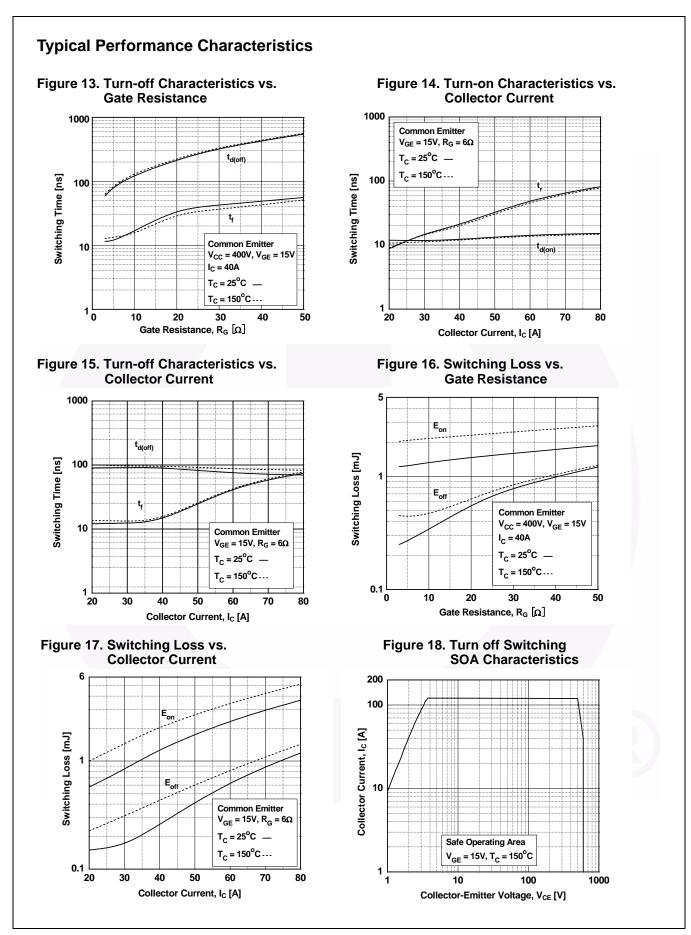


Figure 12. Turn-on Characteristics vs. Gate Resistance

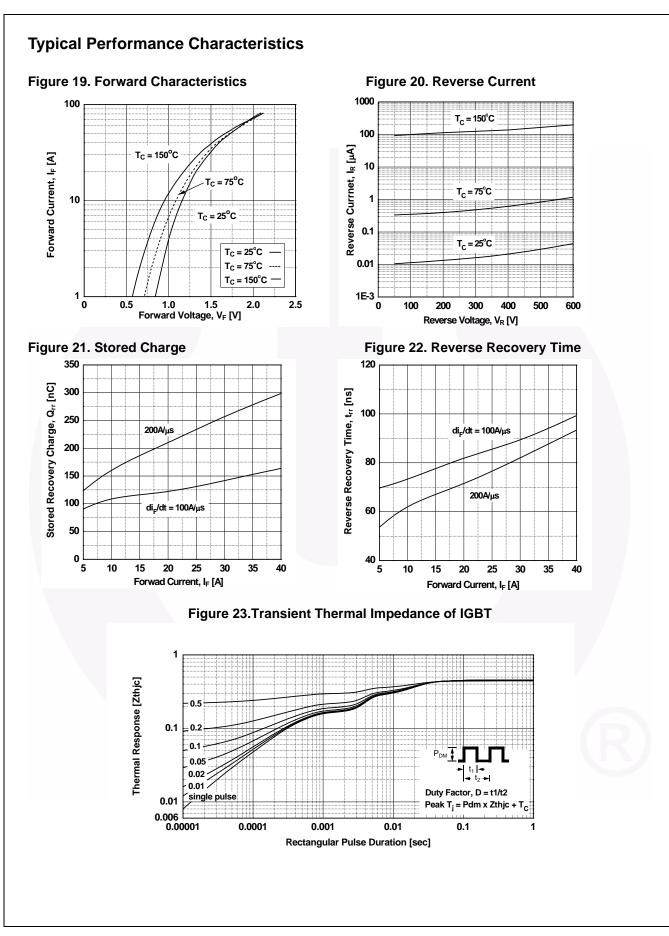


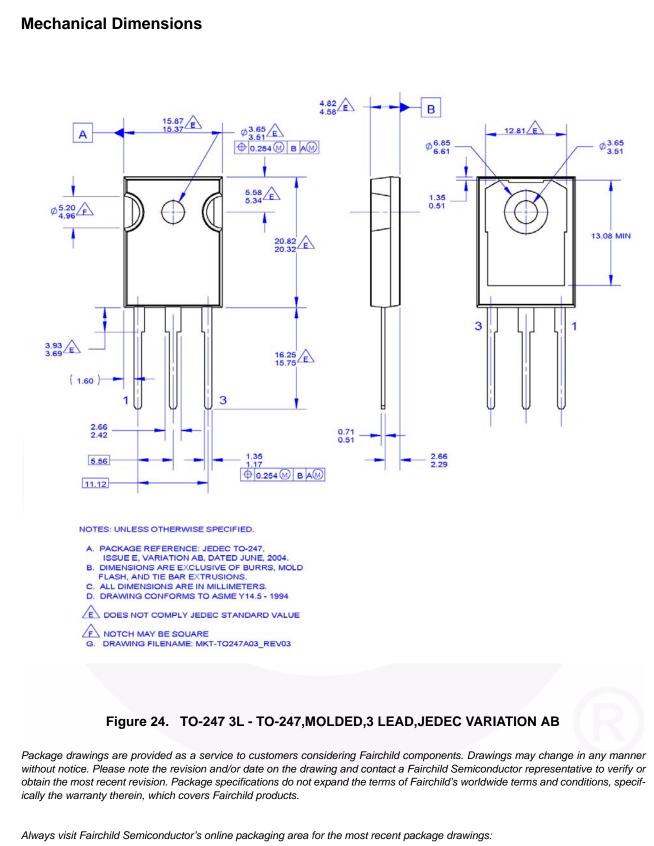
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FGH40N60SMDF — 600 V, 40 A Field Stop IGBT



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